# **G3VM-21PR10**

**MOS FET Relays** 

# Smallest Class in market, USOP Package MOS FET Relays with Low Output Capacitance and ON Resistance (CxR=2.5pF⋅Ω)

• Dielectric strength of 500Vrms between I/O.



**Note:** The actual product is marked differently from the image shown here.

## **RoHS Compliant**

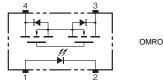
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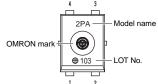
Refer to "Common Precautions".

# ■Application Examples

- Semiconductor test equipment
- Test & measurement equipment
- Communication
- equipment
- Data loggers

# ■Terminal Arrangement/Internal Connections





Note: The actual product is marked differently from the image shown here.

### **■**List of Models

Package type	Contact form	Terminals	Load voltage (peak value) (See note.)	Model	Minimum package quantity  Number per tape & reel
	1a (SPST-NO)	Surface-mounting terminals		G3VM-21PR10	_
USOP4			20V	G3VM-21PR10 (TR05)	500
				G3VM-21PR10 (TR)	1,500

Note 1. Ask you OMRON representative for orders under 1,500 pcs or 500 pcs.

- 2. Tape-cut USOPs are packaged without humidity resistance. Use manual soldering to mount them. Refer to common precautions.
- 3. The AC peak and DC value is given for the load voltages.

# ■Absolute Maximum Ratings (Ta = 25°C)

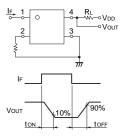
Item		Rating	Unit	Measurement conditions
LED forward current  ED forward current reduction rate		50	mA	
		-0.5	mA/°C	Ta≥25°C
LED reverse voltage		5	V	
Connection temperature		125	°C	
Load voltage (AC peak/DC)		20	V	
Continuous load current (AC peak/DC) ON current reduction rate		200	mA	
ON current reduction rate	Δlo/°C	-2.0	mA/°C	Ta≥25°C
Pulse ON current	lop	600	mA	t=100ms, Duty=1/10
Connection temperature	TJ	125	°C	
Dielectric strength between I/O (See note 1.)		500	Vrms	AC for 1 min
Ambient operating temperature		-40~+85	°C	With no icing or condensation
Ambient storage temperature		-40~+125	°C	With no icing or condensation
Soldering temperature		260	°C	10s
	LED forward current LED forward current reduction rate LED reverse voltage Connection temperature Load voltage (AC peak/DC) Continuous load current (AC peak/DC) ON current reduction rate Pulse ON current Connection temperature lectric strength between I/O e note 1.) bient operating temperature	LED forward current  LED forward current reduction rate  LED forward current reduction rate  LED reverse voltage  Connection temperature  Load voltage (AC peak/DC)  Continuous load current (AC peak/DC)  ON current reduction rate  Δlo/°C  Pulse ON current  Connection temperature  TJ  lectric strength between I/O e note 1.)  vi-o bient operating temperature  Ta  bient storage temperature	LED forward current         IF         50           LED forward current reduction rate         ΔIF/°C         -0.5           LED reverse voltage         VR         5           Connection temperature         TJ         125           Load voltage (AC peak/DC)         VoFF         20           Continuous load current (AC peak/DC)         Io         200           ON current reduction rate         ΔIo/°C         -2.0           Pulse ON current         lop         600           Connection temperature         TJ         125           lectric strength between I/O e note 1.)         VI-O         500           bient operating temperature         Ta         -40~+85           bient storage temperature         Tstg         -40~+125	LED forward current         IF         50         mA           LED forward current reduction rate         ΔIF/°C         -0.5         mA/°C           LED reverse voltage         VR         5         V           Connection temperature         TJ         125         °C           Load voltage (AC peak/DC)         VoFF         20         V           Continuous load current (AC peak/DC)         lo         200         mA           ON current reduction rate         ΔIo/°C         -2.0         mA/°C           Pulse ON current         lop         600         mA           Connection temperature         TJ         125         °C           lectric strength between I/O e note 1.)         VI-O         500         Vrms           bient operating temperature         Ta         -40~+85         °C           bient storage temperature         Tstg         -40~+125         °C

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side

# **■Electrical Characteristics** (Ta = 25°C)

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Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions	
LED forward voltage Reverse current Capacity between terminals		VF	1.0	1.15	1.3	V	IF=10mA	٦.
		lr	-	-	10	μΑ	VR=5V	1
		Ст	-	15	-	pF	V=0, f=1MHz	1
	Trigger LED forward current	IFT	-	1.0	3	mA	lo=100mA	1
0	Maximum resistance with output ON	Ron	-	3	5	Ω	IF=5mA, Io=200mA, t<1s	1
Output	Current leakage when the relay is open	ILEAK	-	-	1	nA	Voff=20V, Ta=25°C	1
Ħ	Capacity between terminals	Coff	-	0.8	1.1	pF	V=0, f=100MHz, t<1s	1
Capacity between I/O terminals		C <sub>I</sub> -O	-	0.4		pF	f=1MHz, Vs=0V	1
Insulation resistance between I/O terminals		Rı-o	1000	-		МΩ	Vi-o=500VDC, RoH≤60%	Ī
Turn-ON time		ton	-	0.04	0.2	ms	I=5mA, RL=200Ω,	
Tur	Turn-OFF time		_	0.13	0.2	ms	V <sub>DD</sub> =10V (See note 2.)	

Note: 2. Turn-ON and Turn-OFF Times



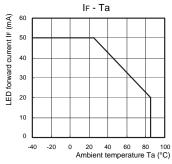
# **■**Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

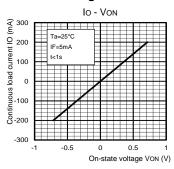
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	Vdd	-	-	16	V
Operating LED forward current	lF	5	7.5	20	mA
Continuous load current (AC peak/DC)	lo	_	-	200	mA
Ambient operating temperature	Та	-20	-	65	°C

# **■**Engineering Data

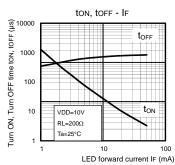
### LED forward current vs. Ambient temperature



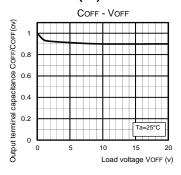
# Continuous load current vs. On-state voltage



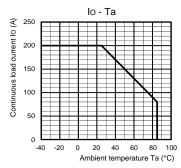
# Turn ON, Turn OFF time vs. LED forward current



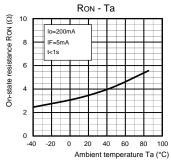
# Output terminal capacitance COFF/COFF(ov) vs. Load voltage



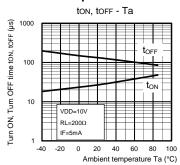
# Continuous load current vs. Ambient temperature



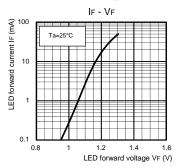
### On-state resistance vs. Ambient temperature



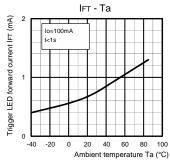
# Turn ON, Turn OFF time vs. Ambient temperature



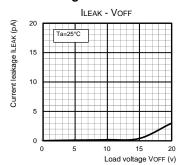
# LED forward current vs. LED forward voltage



Trigger LED forward current vs. Ambient temperature



# Current leakage vs. Load voltage



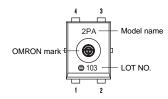
# ■Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

# ■Appearance

# USOP (Ultra Small Outline Package)

USOP4



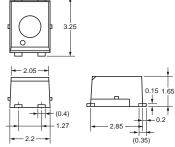
Note: The actual product is marked differently from the image shown here.

### **■**Dimensions (Unit: mm)



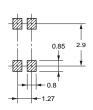
### **Surface-mounting Terminals**

Weight: 0.03g



### **Actual Mounting Pad Dimensions**

(Recommended Value, Top View)



Note: The actual product is marked differently from the image shown here.

Note: Do not use this document to operate the Unit.

**OMRON Corporation** 

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY Contact: www.omron.com/ecb

Cat. No. K195-E1-01

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
 Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.